

General Description

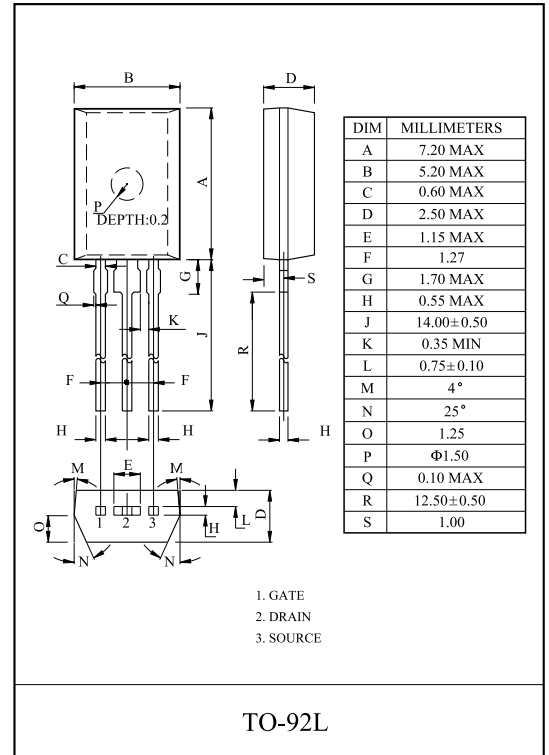
This planar stripe MOSFET has better characteristics, such as fast switching time, low on resistance, low gate charge and excellent avalanche characteristics. It is mainly suitable for switching mode power supplies.

FEATURES

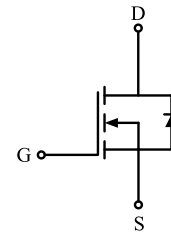
- $V_{DSS} = 600V$, $I_D = 0.70A$
- $R_{DS(ON)} = 4.4$ (Max) @ $V_{GS} = 10V$
- $Q_g(\text{typ}) = 6.0nC$

MAXIMUM RATING (Tc=25 °C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		V_{DSS}	600	V
Gate-Source Voltage		V_{GSS}	± 30	V
Drain Current	$T_C=25$	I_D	0.70	A
	$T_C=100$		0.44	
	Pulsed (Note1)	I_{DP}	4.0	
Single Pulsed Avalanche Energy (Note 2)		E_{AS}	60	mJ
Repetitive Avalanche Energy (Note 1)		E_{AR}	1.5	mJ
Peak Diode Recovery dv/dt (Note 3)		dv/dt	4.5	V/ns
Drain Power Dissipation	$T_C=25$	P_D	5.4	W
	Derate above 25		0.043	W/
	$T_a=25$		1	W
Maximum Junction Temperature		T_j	150	
Storage Temperature Range		T_{stg}	-55 150	
Thermal Characteristics				
Thermal Resistance, Junction-to-Case		R_{thJC}	23	/W
Thermal Resistance, Junction-to-Ambient		R_{thJA}	125	/W



PIN CONNECTION



KF2N60L

ELECTRICAL CHARACTERISTICS (Tc=25)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=250\mu A$, $V_{GS}=0V$	600	-	-	V
Breakdown Voltage Temperature Coefficient	BV_{DSS}/T_j	$I_D=250\mu A$, Referenced to 25	-	0.6	-	V/
Drain Cut-off Current	I_{DSS}	$V_{DS}=600V$, $V_{GS}=0V$,	-	-	10	μA
Gate Threshold Voltage	V_{th}	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.5	-	4.5	V
Gate Leakage Current	I_{GSS}	$V_{GS}=\pm 30V$, $V_{DS}=0V$	-	-	± 100	nA
Drain-Source ON Resistance	$R_{DS(ON)}$	$V_{GS}=10V$, $I_D=0.35A$	-	3.7	4.4	
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=480V$, $I_D=2A$ $V_{GS}=10V$ (Note4,5)	-	6.0	-	nC
Gate-Source Charge	Q_{gs}		-	1.0	-	
Gate-Drain Charge	Q_{gd}		-	2.8	-	
Turn-on Delay time	$t_{d(on)}$	$V_{DD}=300V$ $I_D=2A$ $R_G=25$ (Note4,5)	-	10	-	ns
Turn-on Rise time	t_r		-	20	-	
Turn-off Delay time	$t_{d(off)}$		-	25	-	
Turn-off Fall time	t_f		-	20	-	
Input Capacitance	C_{iss}	$V_{DS}=25V$, $V_{GS}=0V$, $f=1.0MHz$	-	270	-	pF
Output Capacitance	C_{oss}		-	35	-	
Reverse Transfer Capacitance	C_{rss}		-	3.9	-	
Source-Drain Diode Ratings						
Continuous Source Current	I_S	$V_{GS}<V_{th}$	-	-	0.7	A
Pulsed Source Current	I_{SP}		-	-	2.8	
Diode Forward Voltage	V_{SD}	$I_S=0.7A$, $V_{GS}=0V$	-	-	1.4	V
Reverse Recovery Time	t_{rr}	$I_S=2A$, $V_{GS}=0V$, $dI_S/dt=100A/\mu s$	-	290	-	ns
Reverse Recovery Charge	Q_{rr}		-	0.9	-	μC

Note 1) Repetivity rating : Pulse width limited by junction temperature.

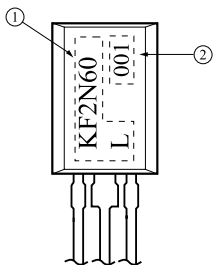
Note 2) $L=28mH$, $I_S=2A$, $V_{DD}=50V$, $R_G=25$, Starting $T_j=25$.

Note 3) $I_S=2A$, $dI/dt=100A/\mu s$, $V_{DD}=BV_{DSS}$, Starting $T_j=25$.

Note 4) Pulse Test : Pulse width $300\mu s$, Duty Cycle 2%.

Note 5) Essentially independent of operating temperature.

Marking



① PRODUCT NAME

② LOT NO

KF2N60L

Fig1. $I_D - V_{DS}$

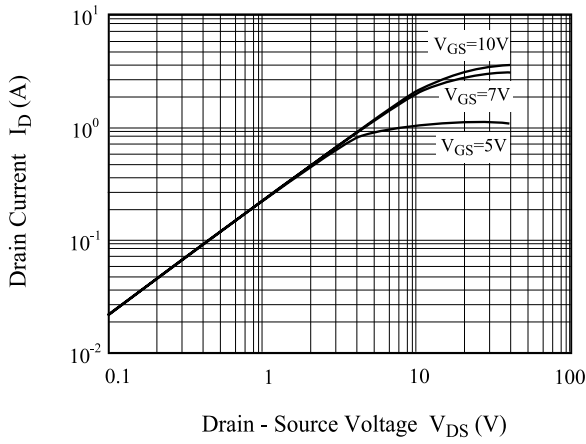


Fig2. $I_D - V_{GS}$

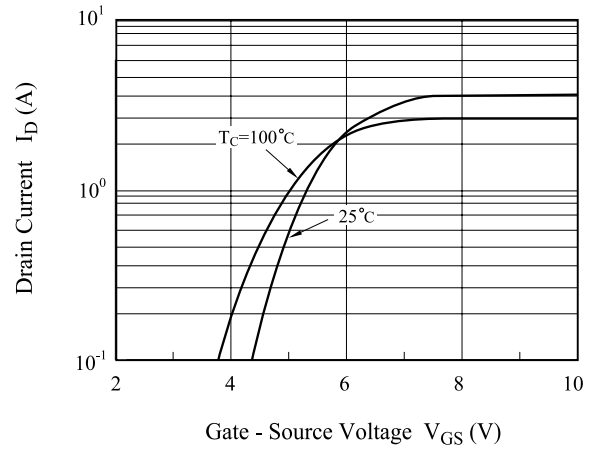


Fig3. $BV_{DSS} - T_j$

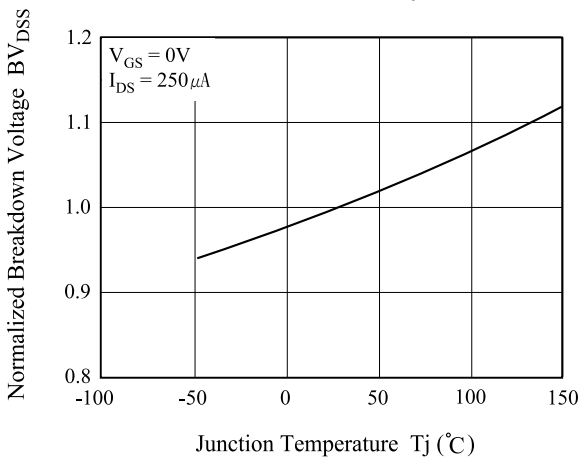


Fig4. $R_{DS(ON)} - I_D$

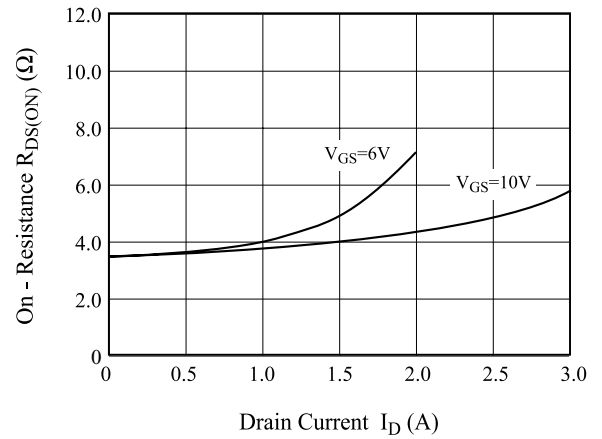


Fig5. $I_S - V_{SD}$

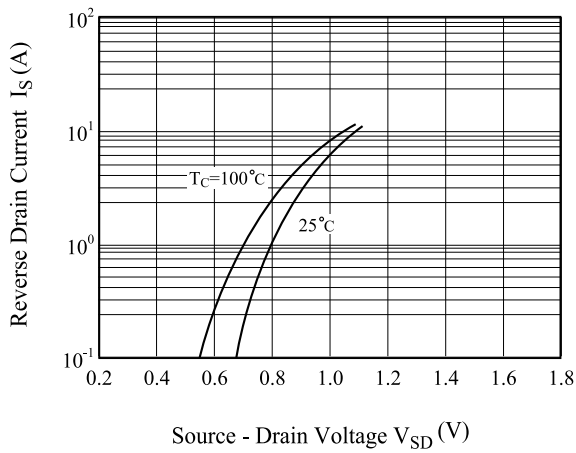
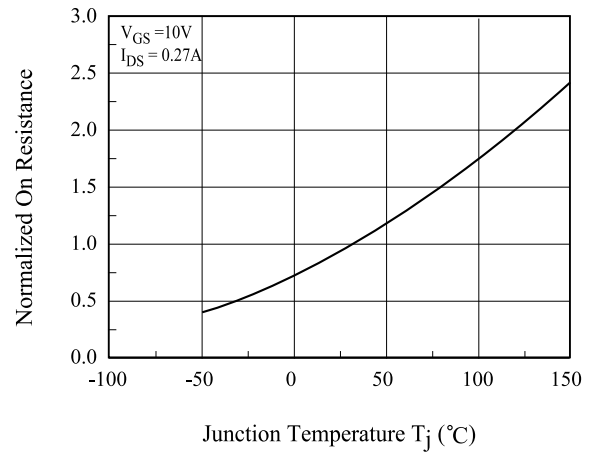


Fig6. $R_{DS(ON)} - T_j$



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Fig 7. C - V_{DS}

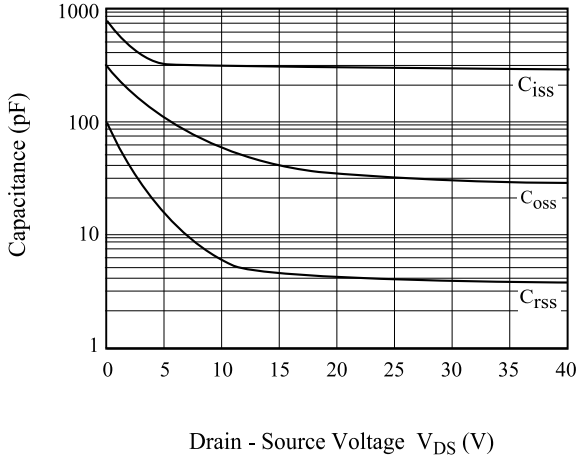


Fig8. Q_g - V_{GS}

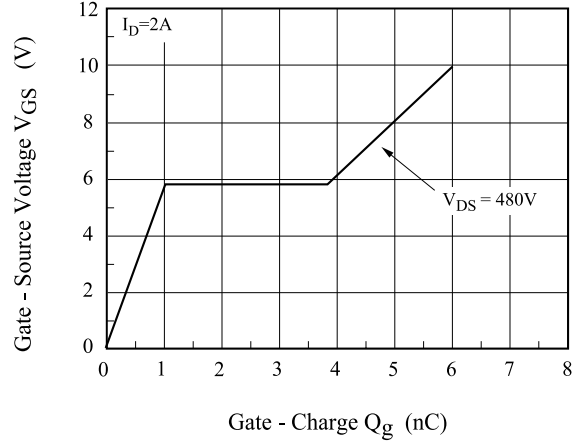


Fig9. Safe Operation Area

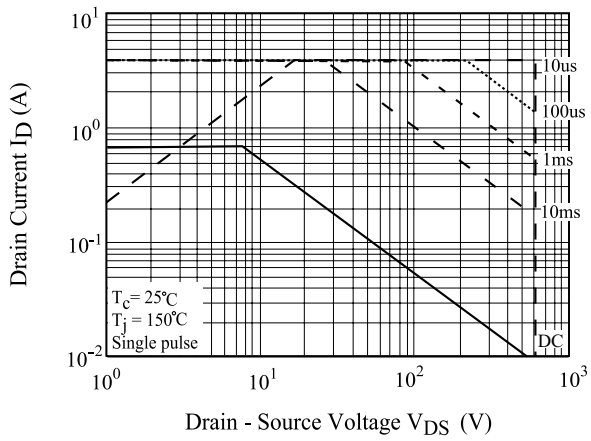
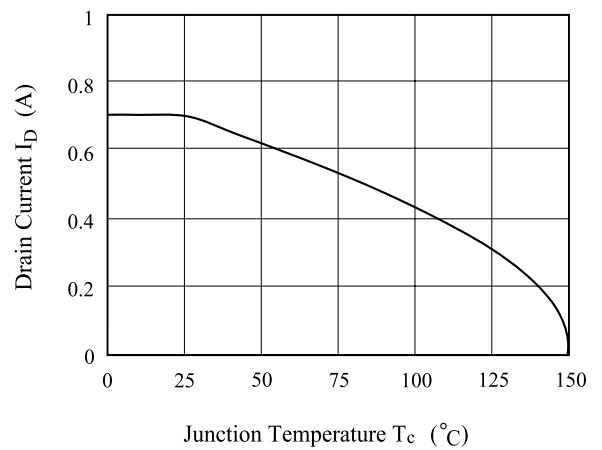


Fig10. I_D - T_j



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Fig11. Transient Thermal Response Curve [R_{thJC}]

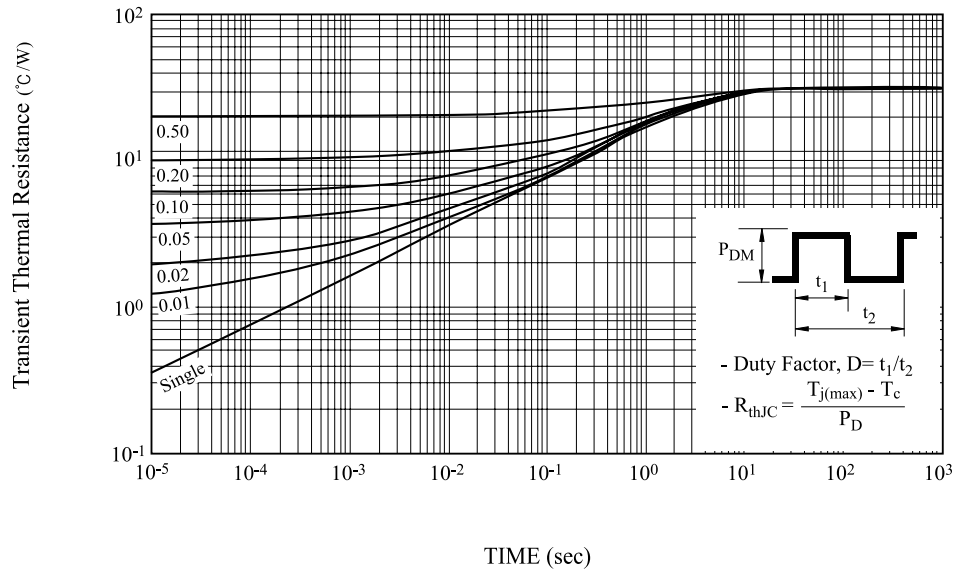
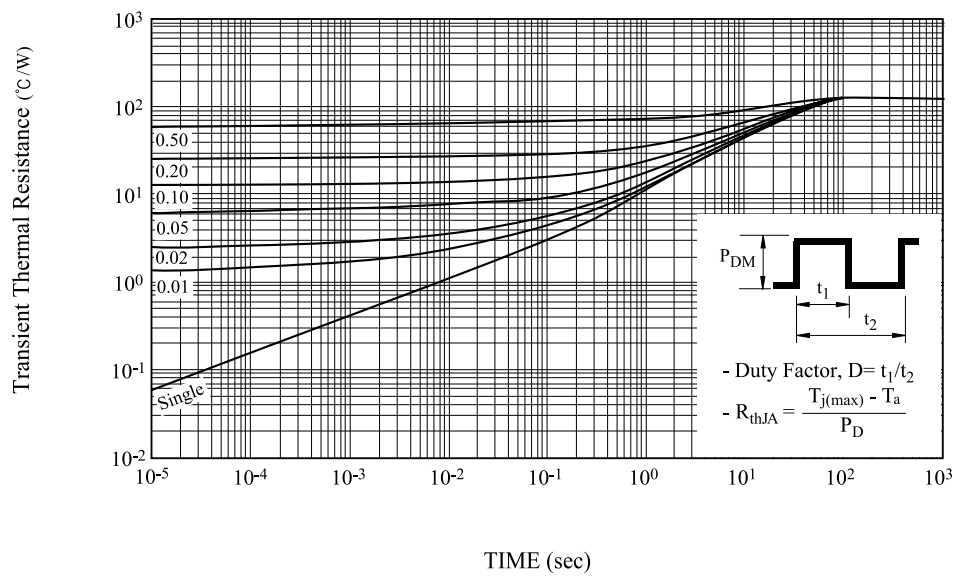


Fig12. Transient Thermal Response Curve [R_{thJA}]



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Fig13. Gate Charge

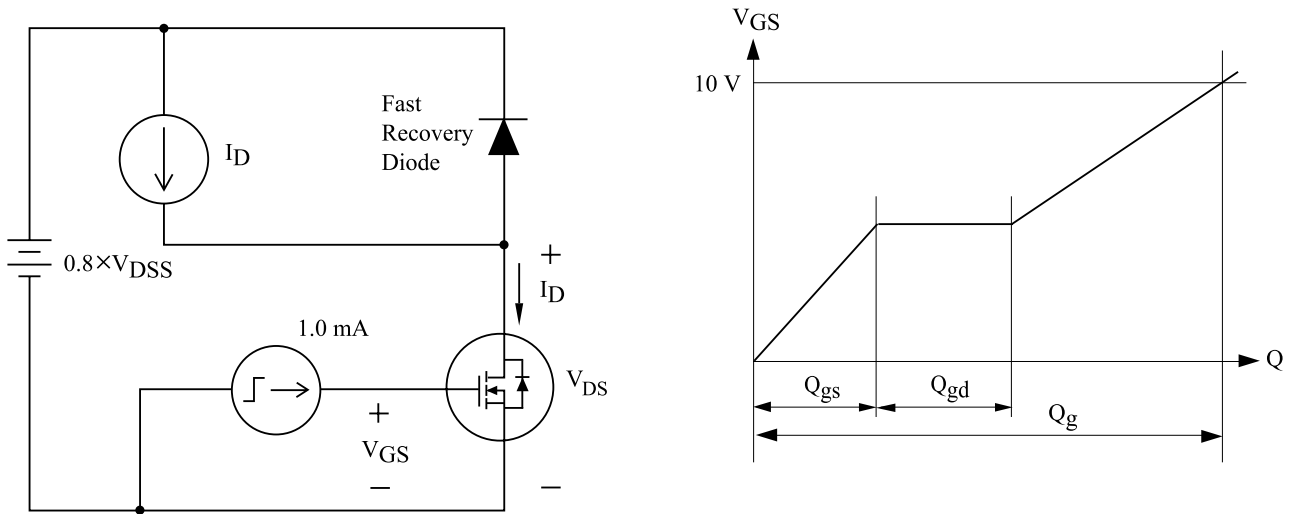


Fig14. Single Pulsed Avalanche Energy

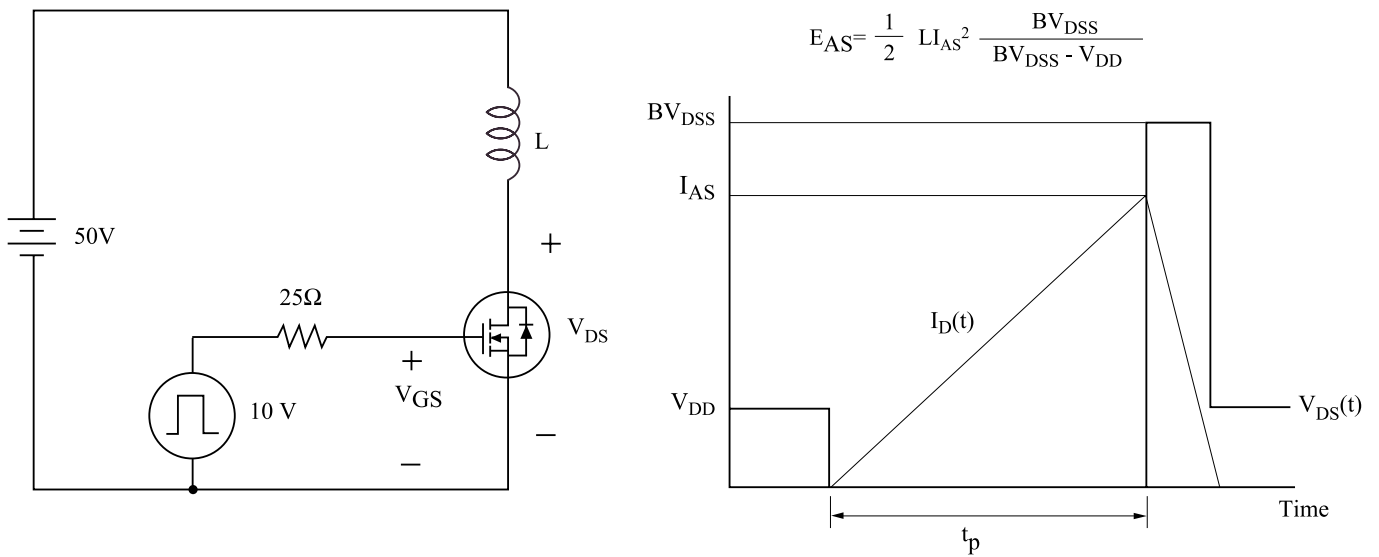


Fig15. Resistive Load Switching

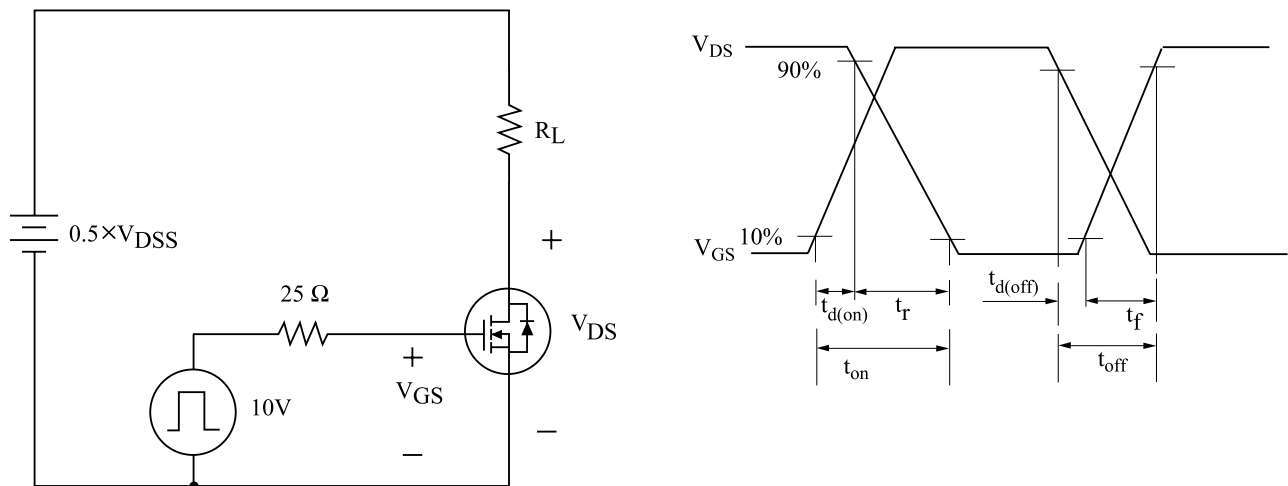


Fig16. Source - Drain Diode Reverse Recovery and dv/dt

